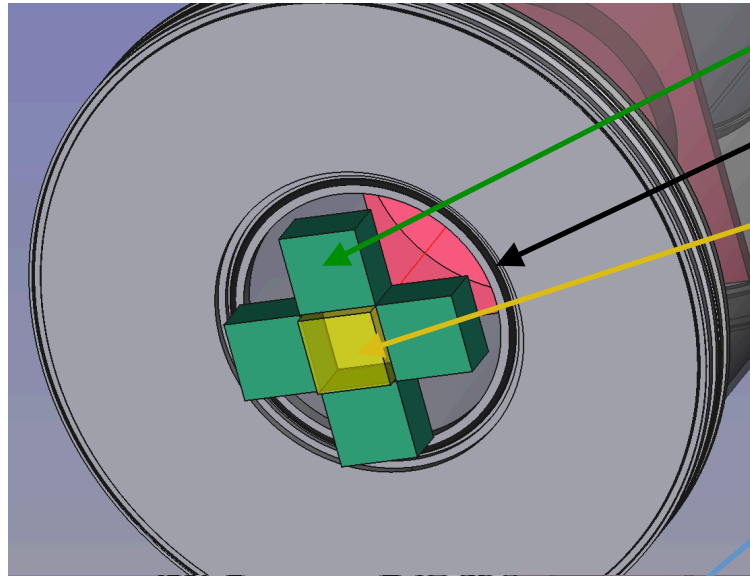


DRICH PROTOTYPE



Sensors

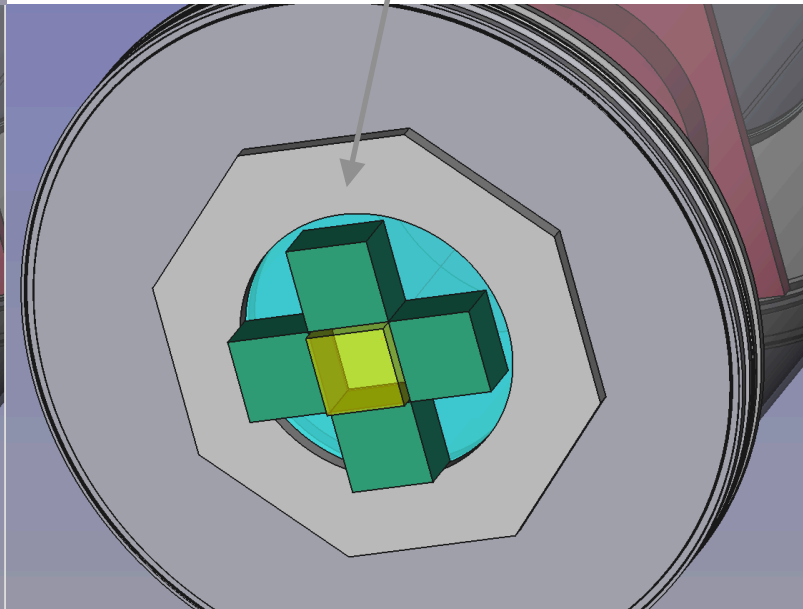
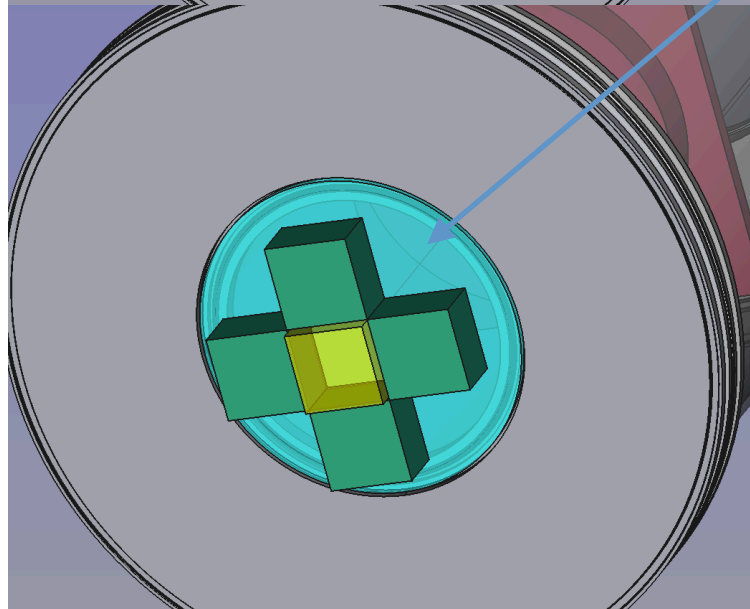
Oring

Aerogel

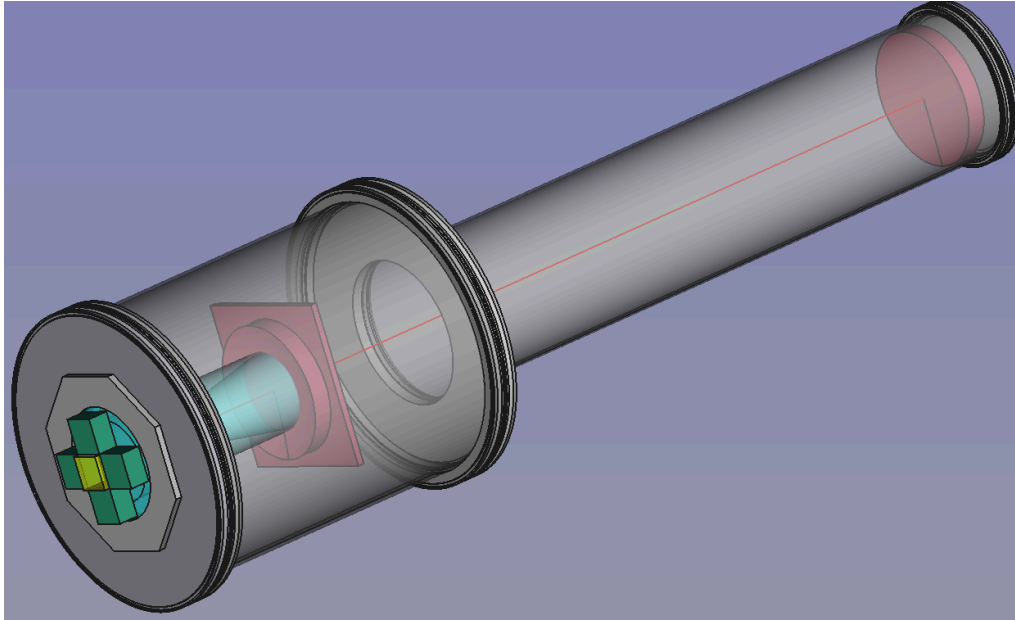
Lucite/Quartz

Sealing flange

Re-use of mRICH concepts
for sensors + electronics



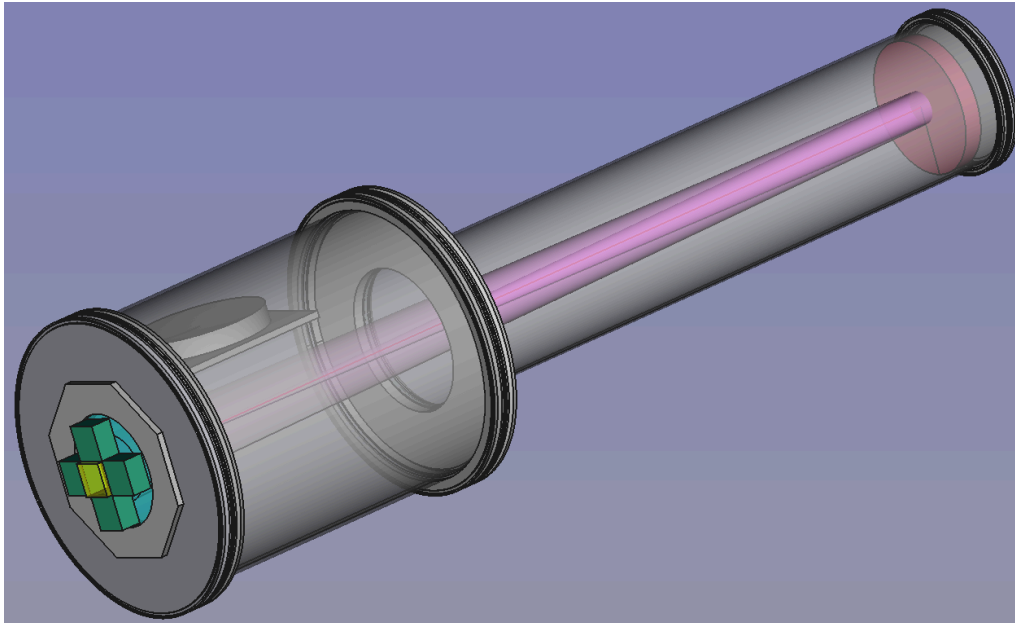
DRICH PROTOTYPE



Two radiators with almost overlapping rings (to optimize the active area)

Configuration 1:

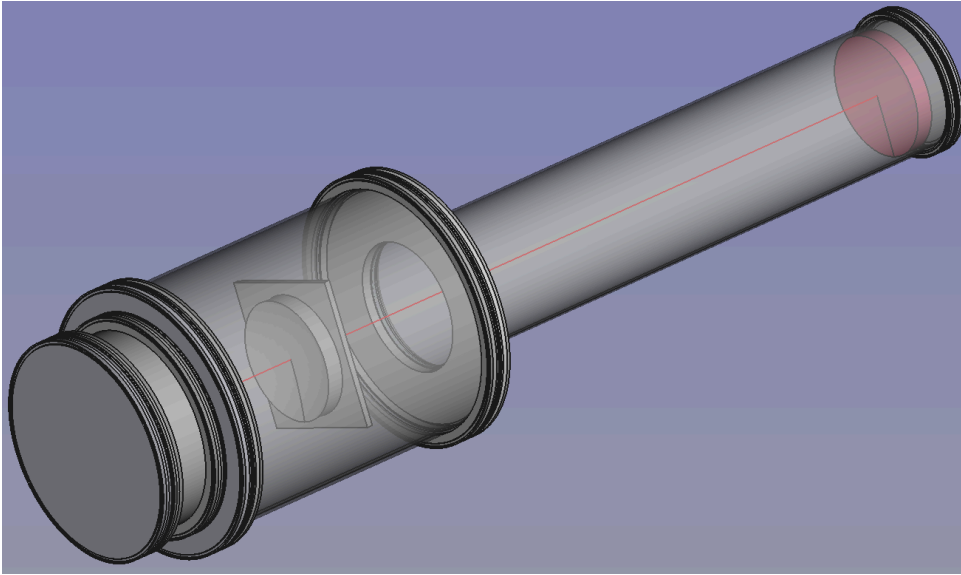
Aerogel ring



Configuration 2:

Gas (freon) ring

DRICH PROTOTYPE



Configuration 3:

Gas exchange / Vacuum

Cost estimates

Vacuum chamber (minimal elements, no mechanical processing):

- Mori meccanica: 4-5 kEUR
- Allectra: 5 kEUR (single chamber)
- VCS: 3.5 kEUR

Mirrors: Edmund protected Aluminum

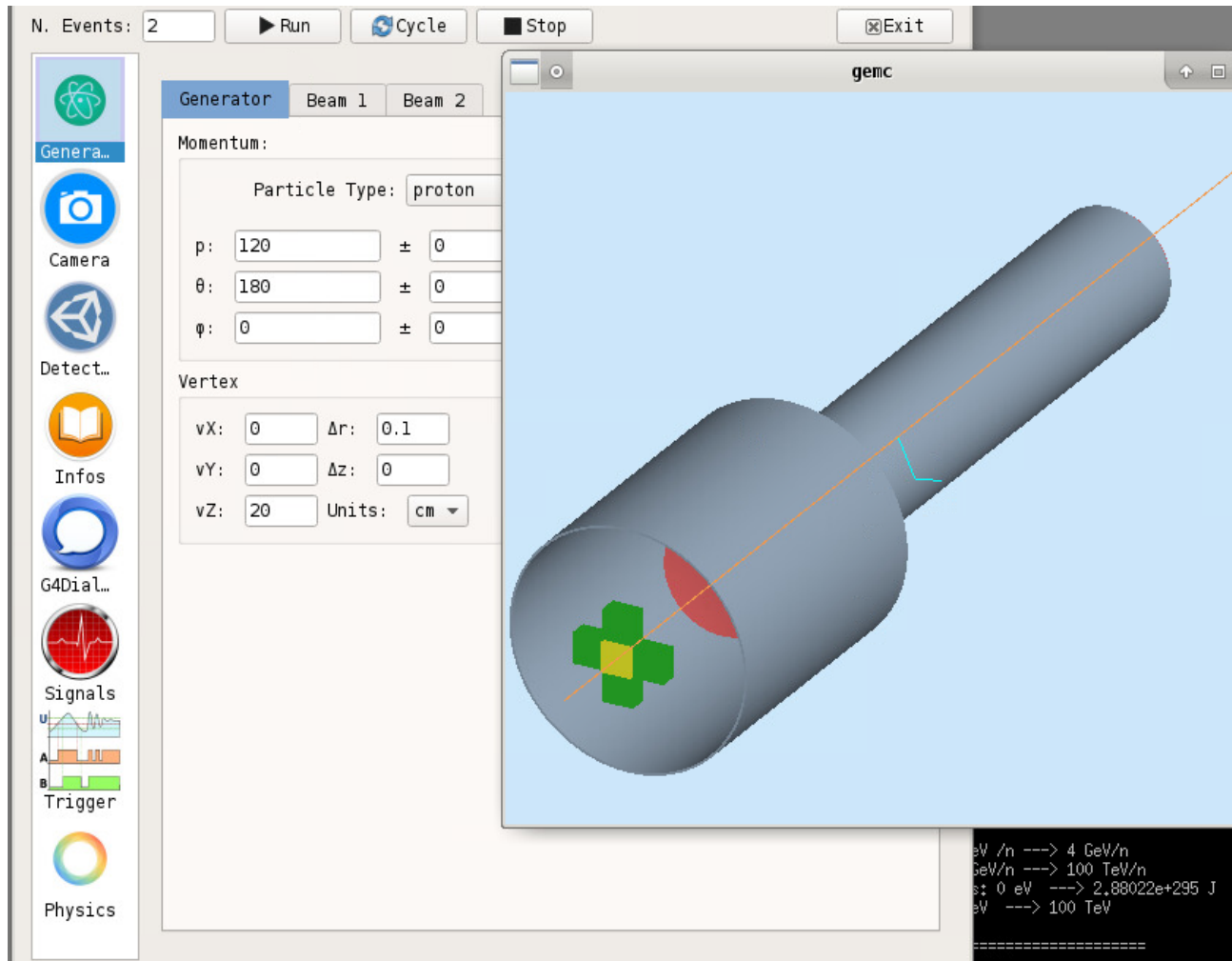
⊙ = 6" (~ 150 mm) F=1200 mm 600 \$

⊙ = 8" (~200 mm) F=1600 mm 830 \$ (34 mm thickness)

Support with micrometric screws: 1500- 2000 \$

DRICH PROTOTYPE

GEMC simulations (docker) with geometry imported from CAD



H13700 READOUT (2018)

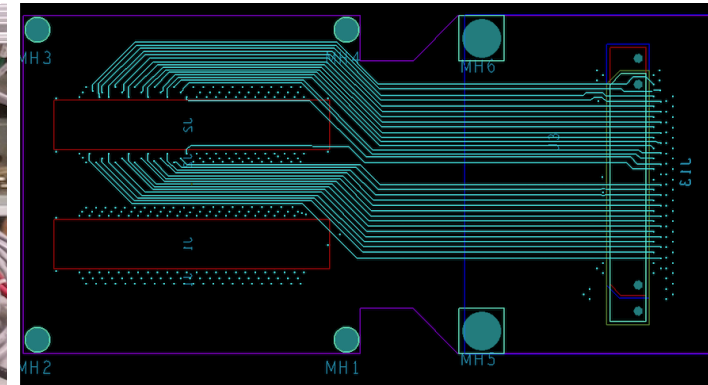
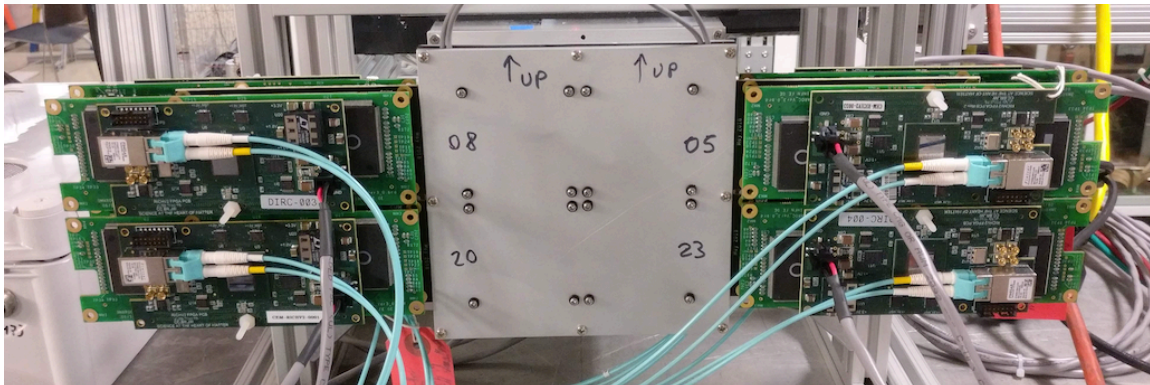
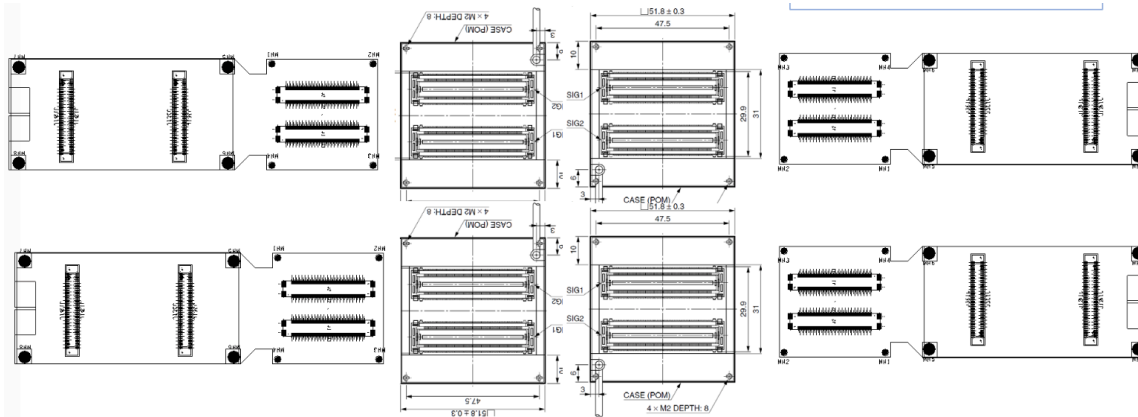
Derived from CLAS12 RICH readout:

- 1024 channels
- MAROC 64 channel parallel digitalization
- FPGA generated 1 ns timestamp
- DAQ protocol based on VME/VSX SSP



Custom adapter boards

- Compact distribution
- Use of existing MAROC boards
- Light and gas tightness



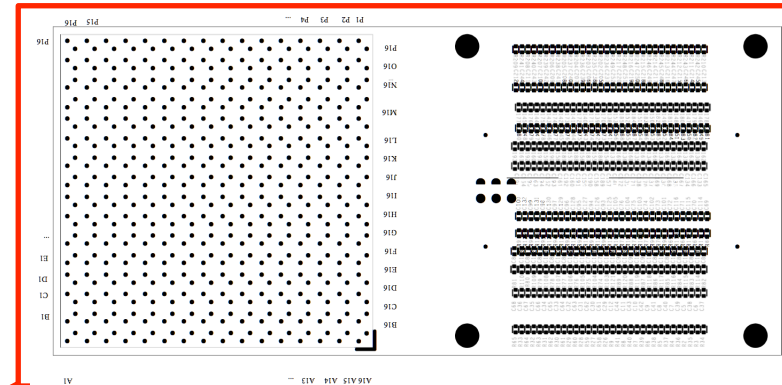
SIPM READOUT (2018)

SiPM might offer a cheaper and more efficient solution, especially in a longer time perspective for other sectors

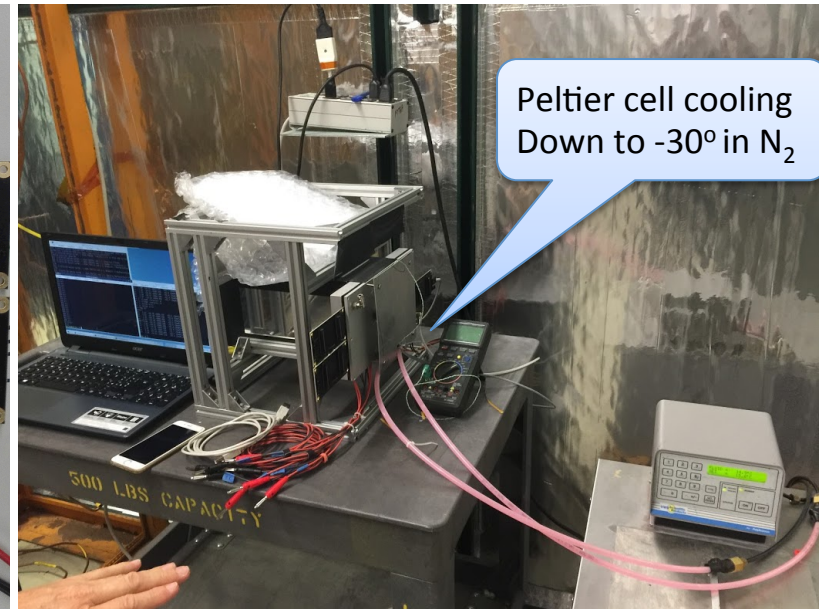
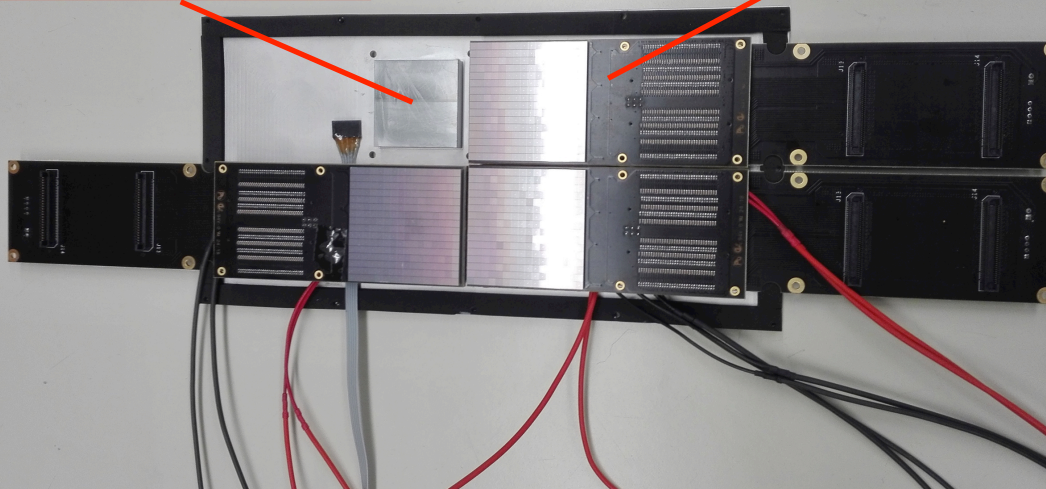
Robust device with low sensitivity to magnetic field
Fast improvement in dark rate and cost
but so far missing radiation hardness

Challenge: cooling integrated into the sensitive readout

Dedicated board for readout and cooling of a surface Mounting SiPM Matrix



Custom cooling plate
Soldered to the board



PULSED LASER TEST BENCHES

Detailed characterization

Sensors: gain, efficiency, cross-talk, radiation tolerance

Electronics: gain, cross-talk, thresholds, time resolution

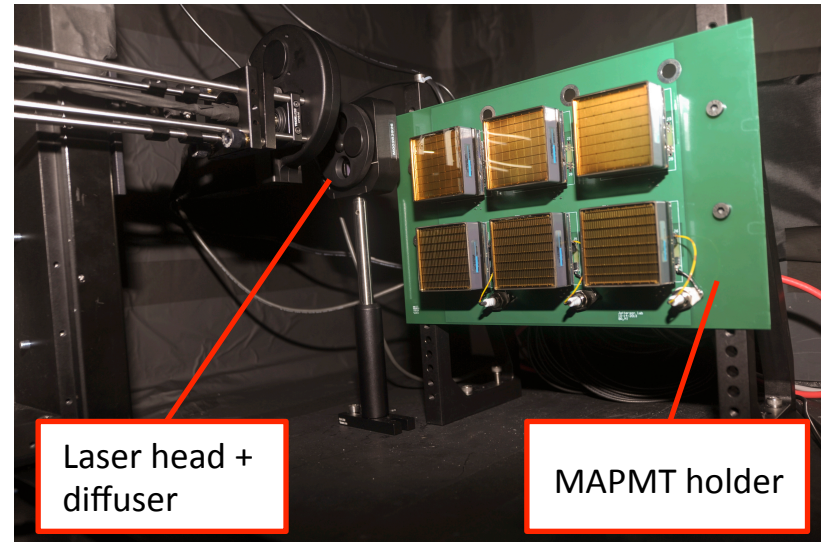
JLab

632 nm picosecond pulsed laser light

Light diffuser to illuminate the whole MAPMT surface

Standardized system with CLAS12 electronics

H8500 6x6 mm² pixel sensor so far



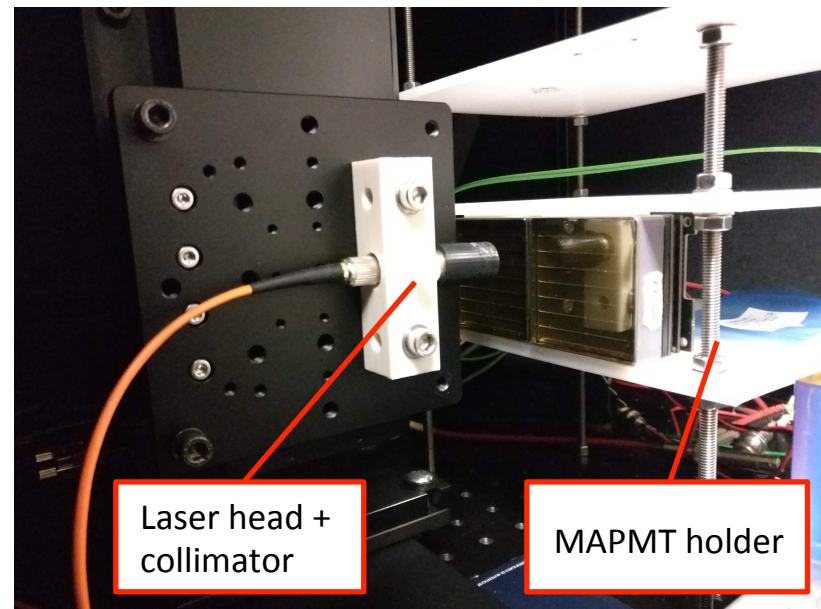
INFN

632 nm and 407 nm picosecond pulsed laser light

Light concentrator to scan the sensor surface

Flexible layout supporting various sensors and

Front-End electronics

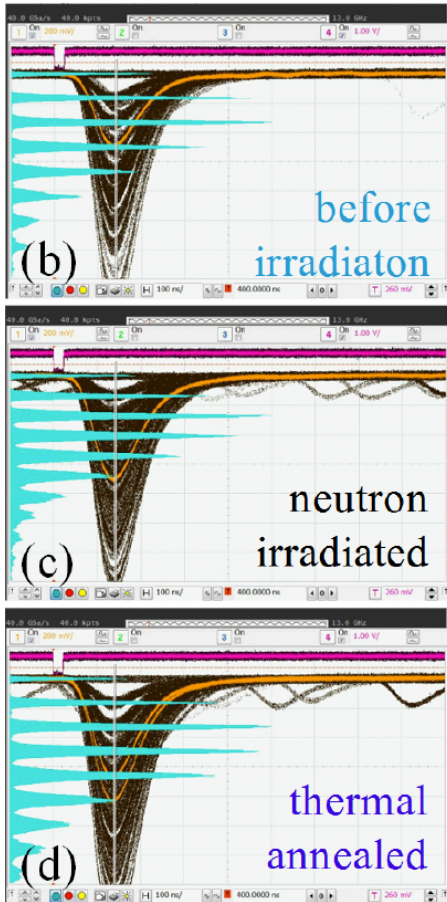


SIPM RADIATION TOLERANCE

T. Tsang et al.
JINST 11 (2016) P12002

I. Balossino et al.
NIMA 876 (2017) 89

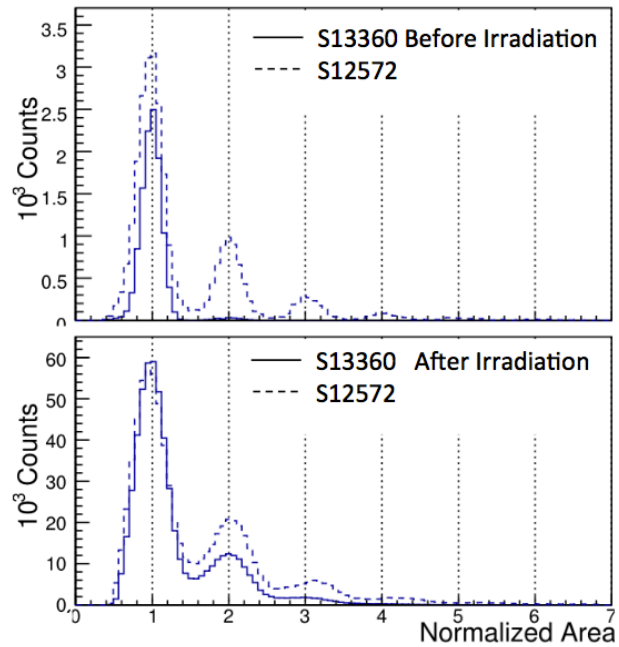
Paolo Carniti
@ RICH 2018



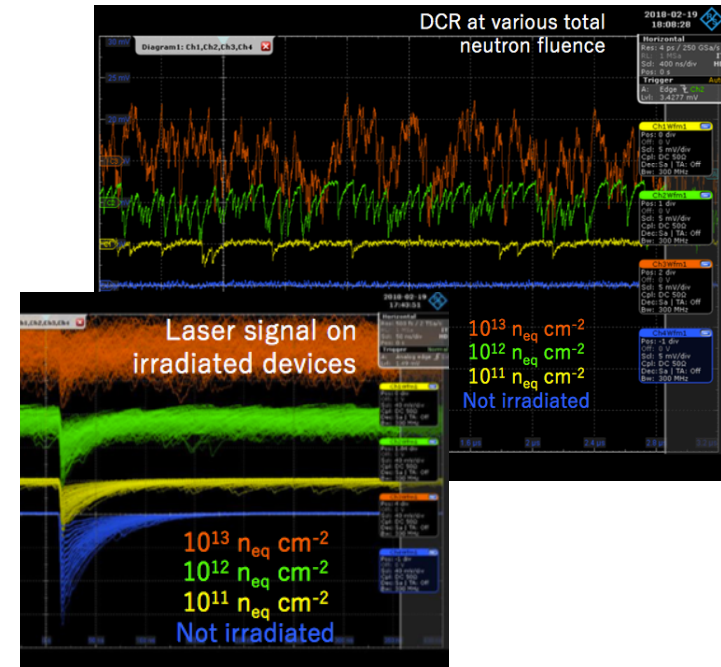
T= 84 K
 $10^9 n_{eq} cm^2$
Annealing at 250 °C

Single-photon capability after irradiation ?

S12572 standard technology
S13360 trench technology



T= 0 C
few $10^9 n_{eq} cm^2$



SiPM: Hamamatsu S13360-1350CS (50 μm cells)

Temperature: -30 °C

Bias: $V_{BR} + 1.5 V$